

Z-PACK | Z-PACK TinMan

TE Internal #: 1934311-1

High Speed Backplane Connectors, 120 Position, Mating Alignment, Guide Slot Mating Alignment Type, 12 Row, 10 Column,

PCB Mount Header, Z-PACK TinMan

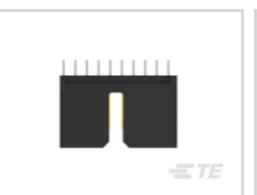
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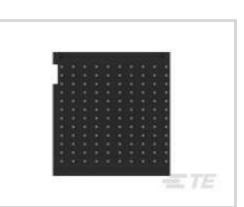


Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors











Connector System: Board-to-Board

Number of Positions: 120

Row-to-Row Spacing: 1.4 mm [.055 in]

Mating Alignment: With

Mating Alignment Type: Guide Slot

Features

Product Type Features

Backplane Module Type	Center
Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Pairs per Column	4
Number of Pairs	40

No

80

120

12

Traditional Backplane

Stackable

Number of Signal Positions

Backplane Architecture

Number of Positions

Number of Rows



Number of Columns	10	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Impedance	100 Ω	
Operating Voltage	250 VAC	
Signal Characteristics		
Differential Impedance	100 Ω	
Number of Differential Pairs per Column	4	
Data Rate	10 Gb/s	
Body Features		
Primary Product Color	Black	
Contact Features		
Contact Mating Area Length	6 mm[.236 in]	
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]	
Contact Type	Pin	
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]	
Contact Mating Area Plating Material	Gold	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Rectangular	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Current Rating (Max)	.5 A	
Termination Features		
Termination Post & Tail Length	2.5 mm[.098 in]	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit	
Mechanical Attachment		
Guide Hardware	Without	
Mating Retention	Without	
PCB Mount Alignment	Without	
PCB Mount Retention	With	
PCB Mount Retention Type	Action/Compliant Tail	
Mating Alignment	With	



Mating Alignment Type	Guide Slot	
Connector Mounting Type	Board Mount	
Housing Features		
Number of Shrouded Sides	2	
End Wall Location	Open	
Housing Material	LCP (Liquid Crystal Polymer)	
Centerline (Pitch)	1.9 mm[.075 in]	
Dimensions		
Connector Length	11.8 mm	
Connector Height	11.8 mm	
Connector Width	20.2 mm	
PCB Hole Diameter	.47 mm	
Row-to-Row Spacing	1.4 mm[.055 in]	
Usage Conditions		
Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Agency/Standard	UL	
Approved Standards	UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Method	Box & Tube, Tube	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235)



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L)nes	not c	ontain	REACH	SVH(.

l -	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

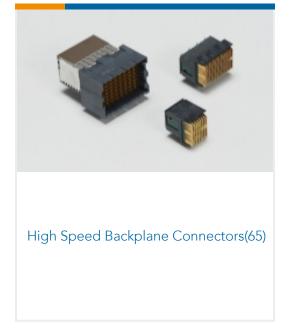


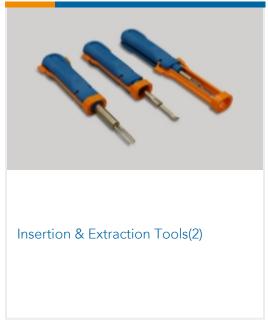






Also in the Series | Z-PACK TinMan





Customers Also Bought











Documents

Product Drawings

Tin Man Header Assy4x10Open

English

CAD Files

Customer View Model

ENG_CVM_1934311-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_1934311-1_A.3d_stp.zip

English

Customer View Model

ENG_CVM_1934311-1_A.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Product Specifications

Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

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Agency Approvals

UL Report

English

UL Report

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English